

iC-TW3 SENSOR SIGNAL CONDITIONER WITH TEMPERATURE COMPENSATION AND LINE DRIVER



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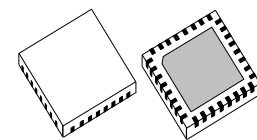
FEATURES

- ♦ Fully differential 3-channel signal conditioning
- ♦ PGS inputs for differential and single-ended signals
- ♦ Overall gain of -3 to 57 dB, adjustable in steps of 0.08 dB
- ♦ Output referred offset range of ± 1.2 V, adjustable in steps of 2 mV
- ♦ Signal bandwidth to 1 MHz and in/out latency below 1 μ s
- ♦ Selectable automatic gain and offset control for encoder applications
- ♦ On-chip or off-chip temperature sensing
- ♦ Temperature drift compensation for gain and offset via programmable look-up-tables
- ♦ Short-circuit-proof outputs: 1 Vpp to 100 Ω , 2 Vpp to 1 k Ω
- ♦ I²C interface to restore device setup from serial EEPROM
- ♦ Bidirectional 1-wire interface for direct RAM and EEPROM access
- ♦ Optical setup link via 1-wire interface operating a photo receiver
- ♦ Single 3.0 V to 5.5 V supply
- ♦ Operating temperature range of -40 to +125 $^{\circ}$ C

APPLICATIONS

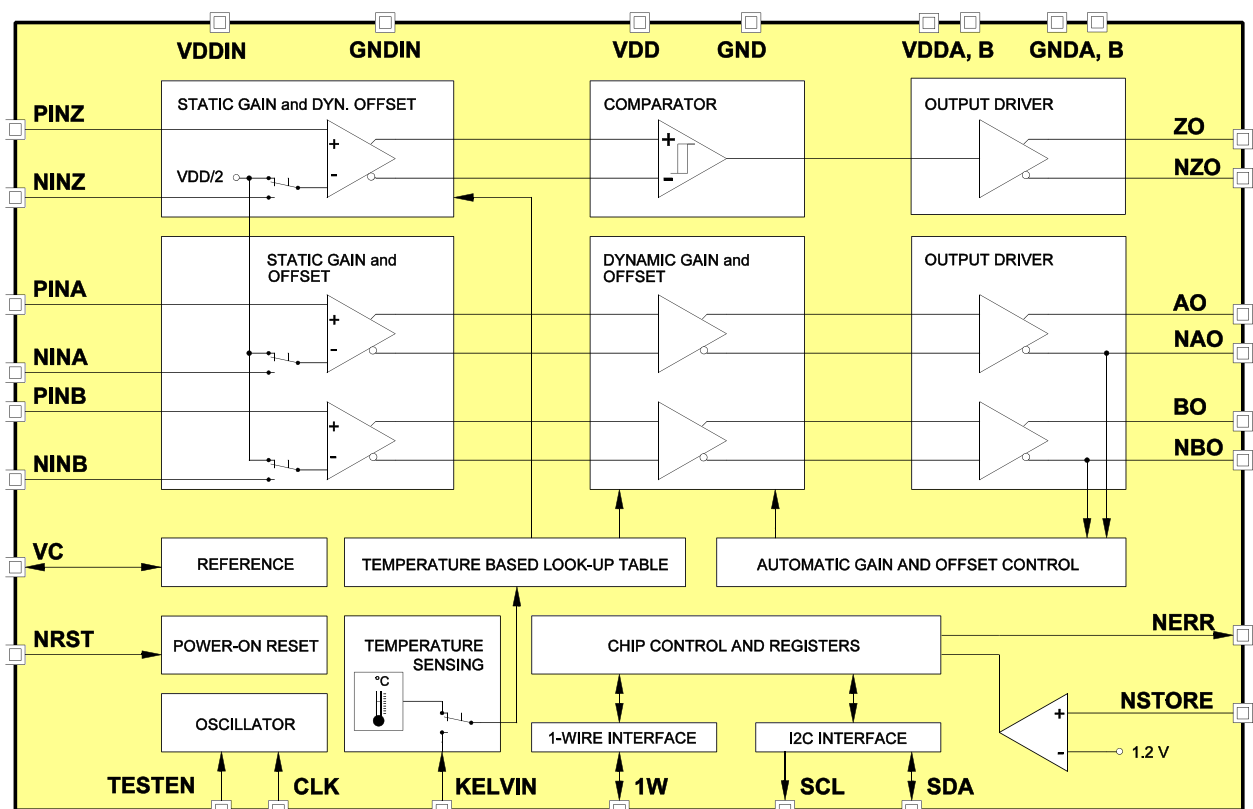
- ♦ Programmable general purpose sensor interface
- ♦ Optical position sensors
- ♦ Magnetic position sensors
- ♦ Incremental position sensors
- ♦ Linear scales

PACKAGES



QFN32

BLOCK DIAGRAM



DESCRIPTION

The general purpose sensor signal conditioner iC-TW3 provides highly accurate non contact trimming of three independent sine/cosine sensor signals. The differential output signals can be calibrated to 1 Vpp or to 2 Vpp, alternatively.

The internal or an external temperature sensor linked to the chip can influence the gain and offset correction by arbitrary temperature-dependent compensation parameters sourced from a look-up table.

For encoder applications an automatic gain and offset control compensates sensor offset voltages and stabilizes the output signal level.

The direct connection of sine/cosine encoders, MR sensor bridges or photosensor arrays is possible and supported by a selectable input impedance.

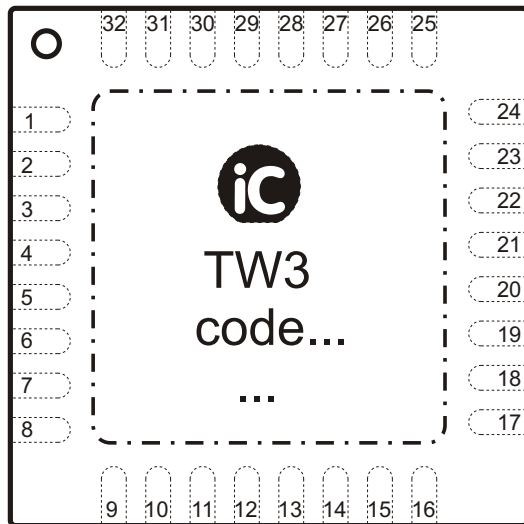
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PACKAGES

PIN CONFIGURATION QFN32 5 mm x 5 mm



PIN FUNCTIONS

No.	Name	Function
1	PINZ	Signal Input Z+
2	NINZ	Signal Input Z-
3	TESTEN	Test Mode Enable Input
4	CLK	External Clock Input
5	NZO	Signal Output Z-
6	ZO	Signal Output Z+
7	GNDB	Driver Ground
8	VDDB	+3...+5.5 V Driver Supply Voltage
9	NBO	Signal Output B-
10	BO	Signal Output B+
11	GND	Digital Ground
12	SCL	I2C Interface, clock line
13	SDA	I2C interface, data line
14	VDD	+3...+5.5 V Digital Supply Voltage
15	GNDA	Driver Ground
16	n.c.	not connected
17	AO	Signal Output A+
18	NAO	Signal Output A-
19	VDDA	+3...+5.5 V Driver Supply Voltage
20	1W	1-Wire Interface, bidirectional port
21	NERR	Error Message Output, active low
22	NRST	External Reset Input, active low
23	NSTORE*	Coefficient Store Input, active low
24	n.c.	not connected
25	NINA	Signal Input A-
26	PINA	Signal Input A+
27	KELVIN	External Temperature Sensor Input
28	GNDIN	Input Ground
29	VDDIN	+3...+5.5 V Input Supply Voltage
30	PINB	Signal Input B+
31	NINB	Signal Input B-
32	VC	1.21 V Reference Voltage Output, Reference Voltage Input

TP TP** Thermal Pad

Notes:

*) Pin NSTORE should be wired to VDD.

**) The Thermal Pad of the QFN package (bottom side) is to be connected to a ground plane on the PCB which must have GND potential.

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ABSOLUTE MAXIMUM RATINGS

These ratings do not imply operating conditions; functional operation is not guaranteed. Beyond these ratings device damage may occur.

Item No.	Symbol	Parameter	Conditions			Unit
				Min.	Max.	
G001	VDDx()	Voltage at VDD, VDDA, VDDDB, VDDIN	referenced to GND, GNDA, GNDB, GNDIN	-0.3	6.0	V
G002	V()	Voltage applied to any other pin	referenced to GND	-0.3	VDD + 0.5	V
G003	V()	Voltage Difference VDDA, VDDDB vs. VDD			0.5	V
G004	V()	Voltage Difference VDDIN vs. VDD			0.5	V
G005	V()	Voltage Difference GNDA, GNDB vs. GND			0.5	V
G006	V()	Voltage Difference GNDIN vs. GND			0.5	V
G007	Vd	ESD Susceptibility Of Signal Outputs: AO, NAO, BO, NBO, ZO, NZO	HBM, 100 pF discharged through 1.5 kΩ		2	kV
G008	Vd	ESD Susceptibility (remaining pins)	HBM, 100 pF discharged through 1.5 kΩ		2	kV
G009	Tj	Junction Temperature		-40	150	°C
G010	Ts	Storage Temperature		-40	150	°C

THERMAL DATA

Item No.	Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
T01	Ta	Operating Ambient Temperature Range		-40		125	°C
T02	Rthja	Thermal Resistance Chip To Ambient	surface mounted to PCB according to JEDEC 51		40		K/W

All voltages are referenced to ground unless otherwise stated.

All currents into the device pins are positive; all currents out of the device pins are negative.

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ELECTRICAL CHARACTERISTICS

Operating conditions: VDD, VDDA, VDDb, VDDIN = 3.0...5.5 V, Tj = -40...125 °C, reference point GND unless otherwise stated

Item No.	Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Total Device							
001	VDDx	Permissible Supply Voltage at VDD, VDDA, VDDb, VDDIN		3.0		5.5	V
002	I(VDDx)	Total Supply Current	VDDx = 3.3 V VDDx = 5.5 V			15 25	mA mA
003	Vc()hi	Clamp-Voltage hi at all pins	Vc()hi = V() - VDD; I() = 10 mA	0.3		1.4	V
004	Vc()lo	Clamp-Voltage lo at all pins	I() = -10 mA	-1.2		-0.3	V
Analog Signal Inputs PINA, NINA, PINB, NINB, PINZ, NINZ							
101	Vin()sig	Permissible Input Voltage Range		1.4		VDD - 1.2 V	V
102	Vin()os	Input Offset Voltage			±5	±15	mV
103	Iin()	Input Current	ENSIGAB = 0, ENSIGZ = 0	-35		35	nA
104	Rpu()	Input Pull-Up Resistor	ENSIGAB = 1, ENSIGZ = 1	2.0	2.5	3	MΩ
105	fg	-3 dB Bandwidth	PGA gain of 36 dB	1.2			MHz
106	CMRR	Common Mode Rejection Ratio	fc < 1 MHz fc < 1 kHz		40 60		dB dB
107	PSRR	Power Supply Rejection Ratio	fc < 1 MHz fc < 1 kHz		40 60		dB dB
108	e _n	Input Voltage Noise	f = 1 kHz f = 100 Hz f = 0.1 to 10 Hz		20 n 25 n 2 μ		V/√Hz V/√Hz V/√Hz
109	ΔDGAIN	Dynamic Gain Step Width			0.08		dB
110	ΔDOFFS	Dynamic Offset Step Width			2		mV
Temperature Sensor and Analog Input KELVIN							
201	T _{or}	Int. Temperature Sensor Operating Range	after calibration of ADC;	-50		150	°C
202	T _{acc}	Device-To-Device Temp. Sensor Variation	after calibration of ADC, Tj = -40 °C to 125 °C		±10		°C
203	Vin()low	Temperature Input Voltage	CELSIUS(7:0) = 10 CELSIUS(7:0) = 245		1.7 0.9		V V
204	Iin()	Input Current at KELVIN	V(KELVIN) = 0 .. VDD	-50		50	nA
205	T()lo	Lo-Temperature ADC Reading, via Register CELSIUS(7:0)	after calibration of ADC; XCELSIUS = 0, internal sensor: Tj = -40 °C XCELSIUS = 1, ext. sensor: V(KELVIN) = 1.7 V		19 10		
206	T()hi	Hi-Temperature ADC Reading, via Register CELSIUS(7:0)	after calibration of ADC; XCELSIUS = 0, internal sensor: Tj = 125 °C XCELSIUS = 1, ext. sensor: V(KELVIN) = 0.9 V		224 245		
Reference Voltage Input/Output VC							
301	Vout(VC)	Reference Voltage Output	VEXT = 0; CL = 100 nF, I() = 0 mA	1.10	1.21	1.35	V
302	Vin(VC)	Permissible Input Voltage Range at VC	VEXT = 1	0		2.21	V
303	Iin(VC)	Input Current at VC	VEXT = 1	-0.1		1	μA
Power-On Reset and Input NRST							
401	VDDon	Turn-On Threshold (power-on release)	increasing voltage at VDD			3.0	V
402	VDDoff	Turn-Off Threshold (power-down reset)	decreasing voltage at VDD		2.6		V
403	Vt()hi	Input Threshold Voltage hi	VDD = 3.3 V +/- 10 % VDD = 5.0 V +/- 10 %	1.5 3.3			V V
404	Vt()lo	Input Threshold Voltage lo	VDD = 3.3 V +/- 10 % VDD = 5.0 V +/- 10 %			0.8 1.0	V V
405	Ipu()	Input Pull-Up Current	V() = 0...VDD - 1 V			-3	μA
406	Vpu()	Input Pull-Up Voltage	Vpu() = VDD - V(), I() = -3 μA			700	mV

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ELECTRICAL CHARACTERISTICS

Operating conditions: VDD, VDDA, VDDb, VDDIN = 3.0...5.5 V, Tj = -40...125 °C, reference point GND unless otherwise stated

Item No.	Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Oscillator CLK, TESTEN							
501	Vt()hi	Input Threshold Voltage hi	VDD = 3.3 V +/- 10 % VDD = 5.0 V +/- 10 %	1.5 3.3			V V
502	Vt()lo	Input Threshold Voltage lo	VDD = 3.3 V +/- 10 % VDD = 5.0 V +/- 10 %			0.8 1.0	V V
503	Ipd()	Input Pull-Down Current	V() = 1 V...VDD	3			µA
504	Vpd()	Input Pull-Down Voltage	I() = 3 µA			700	mV
505	fosc	Oscillator Frequency	TEST_CLK = 1, measured at NERR; CLKDIV = 0 (low active) CLKDIV = 1			2 4	MHz MHz
506	fin()	Permissible External Clock Frequency at CLK				4	MHz
1-Wire Interface 1W							
601	Vs()lo	Saturation Voltage lo	I() = 1 mA			300	mV
602	Isc()lo	Short-Circuit Current lo		2			mA
603	Ipu()	Input Pull-Up Current	V() = 0...VDD - 1 V			-3	µA
604	Vpu()	Input Pull-Up Voltage	Vpu() = VDD - V(), I() = -3 µA			700	mV
605	tr(), tf()	Rise and Fall Time (10/90%)	VDD = 3.3 V, CL = 10 pF			32	ns
606	Vt()hi	Input Threshold Voltage hi	VDD = 3.3 V +/- 10 % VDD = 5.0 V +/- 10 %	1.5 3.3			V V
607	Vt()lo	Input Threshold Voltage lo	VDD = 3.3 V +/- 10 % VDD = 5.0 V +/- 10 %			0.8 1.0	V V
I2C Interface SDA, SCL							
701	Vs()lo	Saturation Voltage lo	I() = 1 mA			400	mV
702	Isc()lo	Short-Circuit Current lo	V() = 1V...VDD	3			mA
703	Ipu()	Pull-Up Current	V() = 0...VDD - 1 V			-3	µA
704	Vpu()	Input Pull-Up Voltage	Vpu() = VDD - V(), I() = -3 µA			700	mV
705	Vt()hi	Input Threshold Voltage hi at SDA	VDD = 3.3 V +/- 10 % VDD = 5.0 V +/- 10 %	1.5 3.3			V V
706	Vt()lo	Input Threshold Voltage lo at SDA	VDD = 3.3 V +/- 10 % VDD = 5.0 V +/- 10 %			0.8 1.0	V V
707	fclk()	Write/Read Clock Frequency at SCL	CLKDIV = 0		100		kHz
708	tbusy()cfg	Duration Of Startup Configuration	CLKDIV = 0, 2 LUT blocks CLKDIV = 0, 16 LUT blocks			20 80	ms ms
Digital Output NERR							
901	Vs()lo	Saturation Voltage lo	I() = 1 mA			400	mV
902	Vs()hi	Saturation Voltage hi	Vs()hi = VDD - V(); I() = -1 mA			400	mV
903	Isc()lo	Short-Circuit Current lo		3			mA
904	Isc()hi	Short-Circuit Current hi				-2.5	mA

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ELECTRICAL CHARACTERISTICS

Operating conditions: VDD, VDDA, VDDb, VDDIN = 3.0...5.5 V, Tj = -40...125 °C, reference point GND unless otherwise stated

Item No.	Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Line Driver Outputs AO, NAO, BO, NBO, ZO, NZO							
B01	Vpk()max	Permissible Output Amplitude	VDD = 3 V, RL = 50 Ω vs. VDD/2			550	mV
B02	Vdc()	Output DC Voltage			VDD / 2		
B03	ΔVout()	Output Voltage Load Dependency	I() = 0...5 mA			50	mV
B04	Isc()lo	Short-Circuit Current lo	pin shorten to VDD/2	12		50	mA
B05	Isc()hi	Short-Circuit Current hi	pin shorten to VDD/2	-50		-12	mA
B06	Isc()	Output Current Limitation hi/lo	V() = 0...VDD		40	50	mA
B07	SR()hi, lo	Slew Rate hi/lo	CL() = 5 nF CL() = 50 pF	3 4			V/μs V/μs
B08	ts	Settling Time	CL() = 5 nF, to 0.1% of final value			1	μs
B09	dbVlin	Output Linearity	100 kHz sine and diff. 1 Vpp output voltage; RL() > 1 kΩ RL() = 120 Ω	80 60			dB dB
B10	CLmax	Maximum Capacitive Output Load	no sustained oscillation		100		nF

PROGRAMMING

Register Map	Page 9	Automatic Compensation	Page 18
		VEXT:	Target voltage select
I2C INTERFACE	Page 11	DYNAMIC:	Automatic compensation control
CHECKSUM: EEPROM Checksum		FREQ:	Automatic adaption frequency
		GENTLE:	Automatic compensation update rate
1-Wire Interface	Page 12	Temperature Sensing	Page 19
		XCELSIUS:	Temperature sensor select
A/B Signal Path	Page 14	FCELSIUS:	Fine temperature offset value
SINGLEIN:	Single ended input functionality	CCELSIUS:	Coarse temperature offset value
ENSIGAB:	Input signal error detection control	CELSIUS:	Current temperature value
CGAINA/B:	Coarse gain select for channel A/B		
COFSA/B:	Coarse offset select for channel A/B	Error Conditions	Page 20
DGAINA/B:	Dynamic gain on channel A/B	ERR_SIG:	Signal unconnected alarm
DOFSA/B:	Dynamic offset on channel A/B	ERR_TEMP:	Temperature alarm
OGAIN:	Output amplifier gain select on channel A/B	ERR_EE:	EEPROM error condition
FILTER:	Signal path filter select		
PDA/B:	Power down control for channel A/B	Temperature Compensation	Page 21
		TEMP:	Temperature compensation control
Z Signal Path (Index)	Page 16	Test Modes	Page 22
SINGLEZ:	Single ended input functionality for index channel Z	PD_CELSIUS:	Power down control for internal temperature sensor
MODEZ:	Channel Z output mode select	TEST_CLK:	Internal test clock oscillator control
BYPASSZ:	Channel Z comparator bypass control	CLKDIV:	Internal clock divider select
GAINZ:	Gain select for channel Z		
OFSZ:	Offset select for channel Z	Typical Applications	Page 23
OGAINZ:	Output amplifier gain select on channel Z		
ENSIGZ:	Input signal error detection control on channel Z		
PDZ:	Power down control for channel Z		
POLARITYZ:	Channel Z polarity select		

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REGISTER MAP								
Adr	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Configuration Registers								
0x00	ROM Device ID[7:0]							
0x01	OGAIN[1:0]		SINGLEIN	FREQ[1:0]		GENTLE	DYNAMIC	TEMP
0x02	VEXT	XCELSIUS	OGAINZ[1:0]		MODEZ	BYPASSZ	SINGLEINZ	POLARITYZ
0x03	ERR_SIG	ERR_TEMP	ERR_EE	TALARM[2:0]			ENSIGZ	ENSIGAB
0x04	EN_NSTORE*			FILTER[1:0]		PDZ	PDB	PDA
0x05	CCELSIUS[3:0]				FCELSIUS[3:0]			
0x06	GAINZ[2]		OFSZ[5:0]					
0x07	GAINZ[1:0]		CGAINB[2:0]			CGAINA[2:0]		
0x08	COFSA[7:0]							
0x09	COFSB[7:0]							
0x0A	DGAINGA[7:0]							
0x0B	DGAINB[7:0]							
0x0C	DOFSA[7:0]							
0x0D	DOFSB[7:0]							
0x0E			VC[1:0]*		CLKSLOW*	CLKDIV	TEST_CLK	PD_CELSIUS
0x0F	Internal Checksum(7:0)							
0x10		TEST_ADC*	TEST_VGA*	TEST_PGA*	VTEST1*	VTEST0*	PD_BG*	TEST_BG*
0x11								
0x12	CELSIUS[7:0]							
0x13								
Internal State Machine Registers								
0x14	INTERNAL USE							
0x15	INTERNAL USE							
0x16	INTERNAL USE							
0x17	INTERNAL USE							
0x18	INTERNAL USE							
0x19	INTERNAL USE							
0x1A	INTERNAL USE							
0x1B	INTERNAL USE							
0x1C	INTERNAL USE							
0x1D	INTERNAL USE							
0x1E	INTERNAL USE							
0x1F	INTERNAL USE							
0x20	INTERNAL USE							
0x21	INTERNAL USE							
0x22	INTERNAL USE							
0x23	INTERNAL USE							
0x24	INTERNAL USE							
0x25	INTERNAL USE							
0x26	INTERNAL USE							
0x27	INTERNAL USE							
Peripheral Registers								
0x40	CELSIUSRAW[7:0]							
0x41				CHANNEL	OFS_P	OFS_N	GAIN_P	GAIN_N
0x42			EE_ERR	XERR_OUT	1OUTPUT	1INPUT	XSTORE	SIG_VALID

REGISTER MAP								
Adr	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x43			EE_IRQ			1INPUT_IRQ	XS- TORE_IRQ	
Notes	Only the configuration registers are user programmable. *) Bits marked by an asterisk are solely intended for IC test and must be kept on zero for normal operation.							

Table 4: Register layout

I2C INTERFACE

Startup

An external I²C 1-kbit EEPROM (e.g. 24xx01 family) is used to store configuration parameters permanently. On power-up and after reset is released iC-TW3 accesses the external EEPROM and reads its device configuration according to Table 6.

EEPROM Checksum

The checksum at address 0x0F contains the 8-bit sum of registers 0x01 to 0x0E plus the 8-bit sum of all LUT bytes up to and including the final block with its breakpoint set to 255.

On startup iC-TW3 calculates the expected checksum and compares it with the value stored at EEPROM address 0x0F. If computed and stored address match normal operation begins. Otherwise, iC-TW3 asserts an error condition and pin NERR is pulled low.

It is the user's responsibility to store the correct checksum in the EEPROM during production programming.

CHECKSUM(7:0) Adr 0x0F; Bit 7:0		R/W
Code	Function	
...	Checksum of EEPROM contents	

Table 5: Checksum

EEPROM Register Map

The 14 bytes of device configuration data are followed by a minimum of 2 to a maximum of 16 lock-up-table blocks (LUT). The LUT block size is 6 bytes each and the final block is indicated by its breakpoint value of 255.

Thus, a minimum of 28 bytes are read with 2 active LUT blocks and 112 bytes are read with 16 active LUT blocks during the configuration phase. Note that the checksum is only calculated up and including the last LUT block. The last LUT block is indicated by a breakpoint value of 255. Further descriptions on LUTs are given in section "Temperature Compensation" on page 21.

Note that the EEPROM address space maps to the 1-wire address 128. Accessing EEPROM address 0 is

therefore equivalent to accessing memory location 128 via the 1-wire interface (see page 12).

EEPROM Address	Description	Corresponding Configuration Register
0x00	<reserved>	-
0x01	Config. 1	0x01
0x02	Config. 2	0x02
0x03	Config. 3	0x03
0x04	Config. 4	0x04
0x05	Temp. Sensing	0x05
0x06	Config. Index	0x06
0x07	Coarse Gain	0x07
0x08	COFSA	0x08
0x09	COFSB	0x09
0x0A	DGAINA	0x0A
0x0B	DGAINB	0x0B
0x0C	DOFSA	0x0C
0x0D	DOFSB	0x0D
0x0E	Test 1	0x0E
0x0F	CHECKSUM	0x0F
EEPROM Address	Description	LUT Block Number
0x10	Breakpoint 0	0
0x11	GAINA	0
0x12	GAINB	0
0x13	OFSA	0
0x14	OFSB	0
0x15	OFSZ	0
0x16	Breakpoint 1 (255)	1
0x17	GAINA	1
0x18	GAINB	1
0x19	OFSA	1
0x1A	OFSB	1
0x1B	OFSZ	1
.	.	.
.	.	.
.	.	.
0x6A	Breakpoint 255	15
0x6B	GAINA	15
0x6C	GAINB	15
0x6D	OFSA	15
0x6E	OFSB	15
0x6F	OFSZ	15

Table 6: EEPROM register map

1-WIRE INTERFACE

The 1-wire interface provides read and write access to the register bank and to the external EEPROM. When read access is not required an infrared phototransistor can be directly connected to the pin in order to build a cost effective wireless write-only port for in-field or production programming.

The communication bit stream is pulse-width modulated (PWM) as shown in Figure 1. A zero-bit is en-

coded as a short high followed by a long low. A one-bit is encoded as a long high followed by a short low.

The modulated signal is independent of the receiver or the transmitted clock frequency. Since iC-TW3 uses a free-running oscillator it is important to implement a robust, frequency insensitive protocol.

1- wire timing

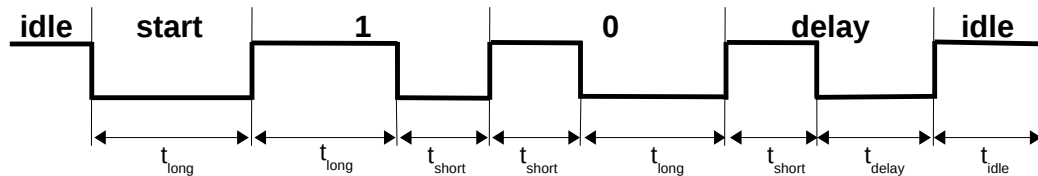


Figure 1: Pulse width modulation bit stream

Parameter	Description	min	max
t_{start}	Low time start condition (Master only)	1 ms	
t_{long}	Unit time long (Master and iC-TW3)	$t_{short} + 10 \mu s$	400 μs
t_{short}	Unit time short (Master and iC-TW3)	35 μs	$t_{long} - 10 \mu s$
t_{delay}	Delay on register read (iC-TW3 only)	35 μs	
t_{idle}	Interface idle before next access Access was write to external EEPROM Access was not write to external EEPROM	8 ms 3 ms	

Table 7: 1-Wire interface timing

Addressing

The EEPROM address 0x00 maps to the 1-wire address 128. Accessing EEPROM address 0 is therefore equivalent to accessing memory location 128 through the 1-wire interface. All other 1-wire addresses are thus determined by adding 128 to the EEPROM address of interest.

Write Sequence

Figure 2 describes the write sequence of the 1-wire interface. On an idle wire, a write sequence is initiated

by generating a start condition followed by the write command (000) and by the address and register data.

Read Sequence

A read sequence is depicted in Figure 3. After the start condition the read command (001) is followed by the register address. The master then releases the wire and iC-TW3 begins to pull low while internally accessing the data. When the data is ready it is produced while following the same PWM rules valid for the master.

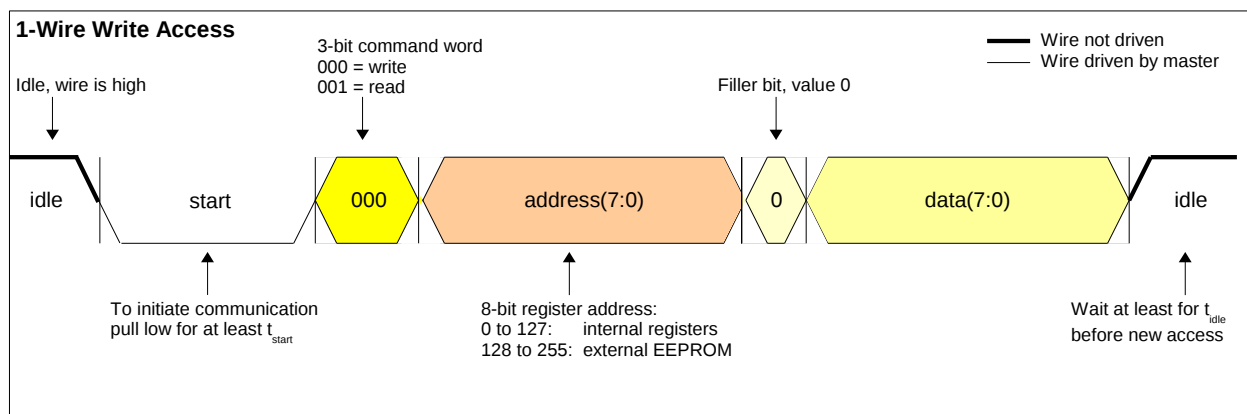


Figure 2: Register write sequence

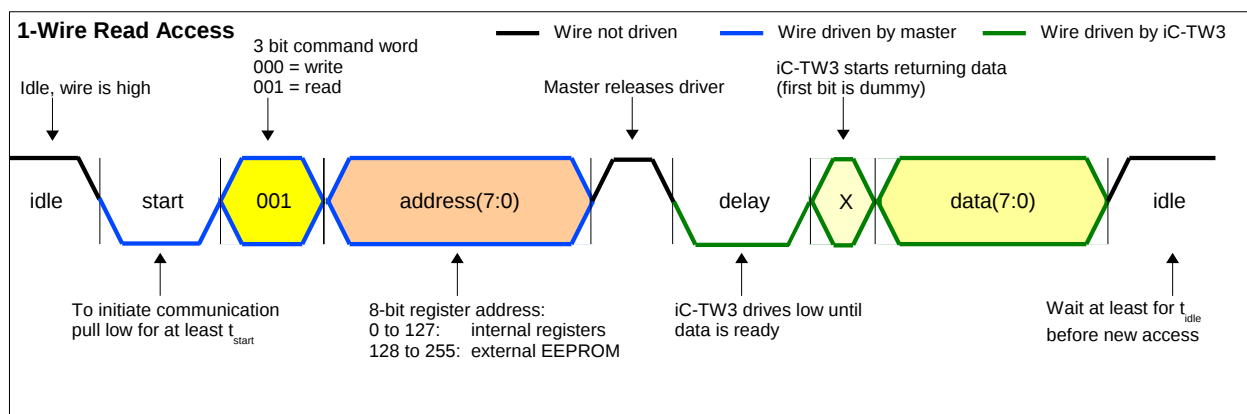


Figure 3: Register read sequence

A/B SIGNAL PATH

iC-TW3 incorporates two analog gain paths called channel A and B, respectively. Gain and offset of both paths are independently controlled and temperature

compensated. Figure 4 depicts a diagram of a single signal path, Table 8 below summarizes gain and offset characteristics.

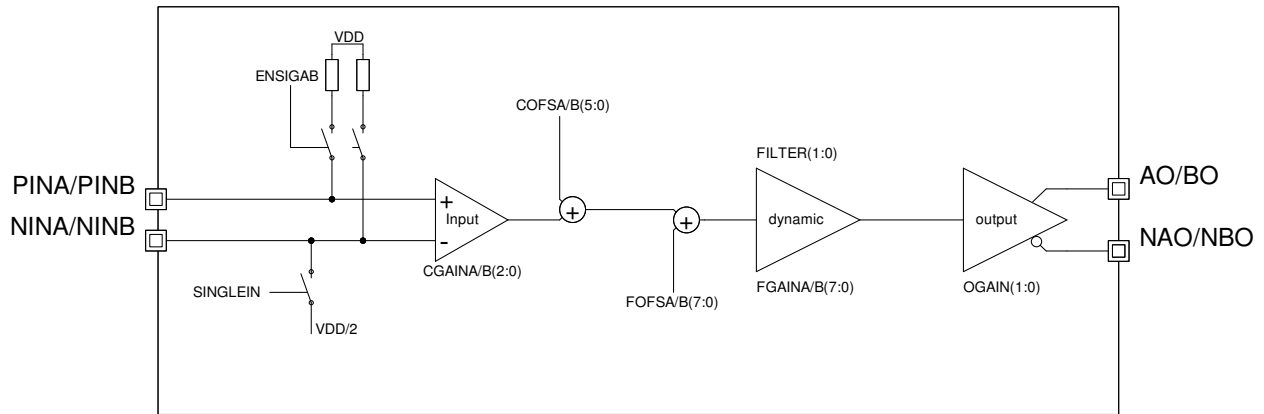


Figure 4: The A/B signal path

	Input Amplifier	Dynamic Amplifier	Output Amplifier	Composite
Gain range	0..36 dB	-2..18.4 dB	-3 dB, 0 dB, 6 dB	-5..60 dB
Gain step	6.0 dB	0.08 dB		
Offset range input referred	$\frac{1.24 V}{gain_{input}}$	$\frac{0.25 V}{gain_{input}}$		$\frac{1.49 V}{gain_{input}}$
Offset step input referred	$\frac{40 mV}{gain_{input}}$	$\frac{2 mV}{gain_{input}}$		
	$gain_{input} = 10^{\frac{gain_of_input_amplifier\ in\ dB}{20}}$			

Table 8: Overview of gain and offset characteristics

Single ended signals

Single ended input functionality is provided by connecting the negative input terminal (pins NINA and NINB) to an internally generated voltage of $V_{DD}/2$. This is enabled by setting the control bit *SINGLEIN* to 1. Alternatively, an externally generated reference voltage may be applied to the negative input terminals.

SINGLEIN		Adr 0x01; Bit 5	R/W
Code	Function		
0	A and B inputs are differential (<i>default</i>)		
1	A and B inputs are single ended		

Table 9: Single ended input functionality

Input error detection

Weak input pull-up resistors are enabled by setting control bit *ENSIGAB* to 1. The resistors are at minimum 2.0 MΩ. When driving the input with a high impedance source it might be necessary to disable the pull-up resistors to avoid excessive signal distortion. The pull-up resistors are used to sense floating

or damaged sensor connections. Any input terminal left unconnected is pulled to V_{DD} and triggers a sensor error condition *err_sig*.

ENSIGAB		Adr 0x03; Bit 0	R/W
Code	Function		
0	Pull-up resistors disconnected and error reporting disabled (<i>default</i>)		
1	Pull-up resistors and error reporting active on A/B inputs		

Table 10: Input signal error detection control

Gain and offset

Registers *CGAINA(2:0)* and *CGAINB(2:0)* are used to set the coarse gain. Coarse gain is static and it is not changed by the temperature or automatic compensation algorithm.

The highest legal value for *CGAINA(2:0)* and *CGAINB(2:0)* is 6. Equivalently registers *COFSA(5:0)* and *COFSB(5:0)* are used to control the static off-

set of the input signal. Note that $COFSA(5:0)$ and $COFSB(5:0)$ are in 2's complement format and their value range is limited from -31 to +31.

CGAINA(2:0)	Adr 0x07; Bit 2:0	R/W
CGAINB(2:0)	Adr 0x07; Bit 5:3	R/W
Code	$gain = cgain \times 6 \text{ dB}$	
0x00	0 dB (default)	
0x01	6 dB	
...		
0x06	36 dB	

Table 11: Coarse gain select for channel A/B

COFSA(7:0)	Adr 0x08; Bit 7:0	R/W
COFSB(7:0)	Adr 0x09; Bit 7:0	R/W
Code 2'sK	Code 5:0, and decimal	$offset = cofsb \times 40 \text{ mV}$
0xE1	0x21, -31	-1240 mV
...	...	
0xFF	0x3F, -1	-40 mV
0x00	0x00, 0	0 mV (default)
0x01	0x01, +1	40 mV
...	...	
0x1F	0x1F, +31	1240 mV

Table 12: Coarse offset select for channel A/B

DGAINA(7:0)	Adr 0x0A; Bit 7:0	R/W
DGAINB(7:0)	Adr 0x0B; Bit 7:0	R/W
Code	$gain = dgain \times 0.08 \text{ dB} - 2 \text{ dB}$	
0x00	-2 dB (default)	
...		
0x19	0 dB	
0x1A	0.08 dB	
...		
0xFF	18.4 dB	

Table 13: Dynamic gain select for channel A/B

DOFSA(7:0)	Adr 0x0C; Bit 7:0	R/W
DOFSB(7:0)	Adr 0x0D; Bit 7:0	R/W
Code	$offset = cofsb \times 2 \text{ mV}$	
0x81	-254 mV	
...		
0xFF	-2 mV	
0x00	0 mV (default)	
0x01	2 mV	
...		
0x7F	254 mV	

Table 14: Dynamic offset select for channel A/B

Value $FGAINA/B$ and $FOFSA/B$ are fine gain and offset control respectively. They are calculated dynamically according to the temperature compensation algorithm. **In case temperature compensation is not**

enabled the values of $FGAINA/B$ and $FOFSA/B$ are equal to the register values in $DGAINA/B(7:0)$ and $DOFSA/B(7:0)$. Refer to chapter "Temperature Compensation" on page 21 for a detailed explanation of fine gain and fine offset calculations. $DGAINA/B(7:0)$ and $DOFSA/B(7:0)$ can be programmed to a fixed value or it is automatically updated when dynamic adaption is enabled.

Output driver

The output amplifier is capable of driving a 100Ω differential load and is stable with capacitive loads of up to 100 nF . Control register $OGAIN(1:0)$ is used to select the output amplifier gain. A gain of -3 dB is useful to accommodate input signals larger than 1 V and gain of +6 dB will provide a 1 Vpp single-ended output. Note that the selected output amplifier gain will influence the automatic gain compensation. Refer to section "Automatic Compensation" on page 18 for details.

OGAIN(1:0)	Adr 0x01; Bit 7:6	R/W
Code	Function	
0x00	0 dB (default)	
0x01	reserved	
0x02	+6 dB	
0x03	-3 dB	

Table 15: Output amplifier gain on channel A/B

A programmable 1st-order low-pass filter can be enabled to limit the path bandwidth. The filter cut-off frequency can be set via the $FILTER(1:0)$ register.

FILTER(1:0)	Adr 0x04; Bit 4:3	R/W
Code	Function	
0x00	1 MHz (default)	
0x01	500 kHz	
0x02	200 kHz	
0x03	reserved	

Table 16: Signal path filter

In order to save power the complete signal path can be disabled using the control bits PDA and PDB respectively. When disabled the outputs are high impedance. The dynamic adaption should be disabled when either channel A or B is disabled.

PDA	Adr 0x04; Bit 0	R/W
PDB	Adr 0x04; Bit 1	R/W
Code	Function	
0	Channel A/B is enabled (default)	
1	Channel A/B is powered down	

Table 17: Power down control on channel A/B

Z SIGNAL PATH (INDEX)

A third analog path is used for index signal processing frequently found in encoder applications. Refer to Figure 5 for an overview. An input amplifier with a gain range of 0 to 36 dB is used to amplify the index signal to an intermediate level. The input amplifier employs

output referred offset correction. This is used to eliminate inherent amplifier offset as well as sensor offset. Additionally, the same offset correction is used to skew the comparator shift point to a desired level. The offset correction is temperature compensated with a LUT.

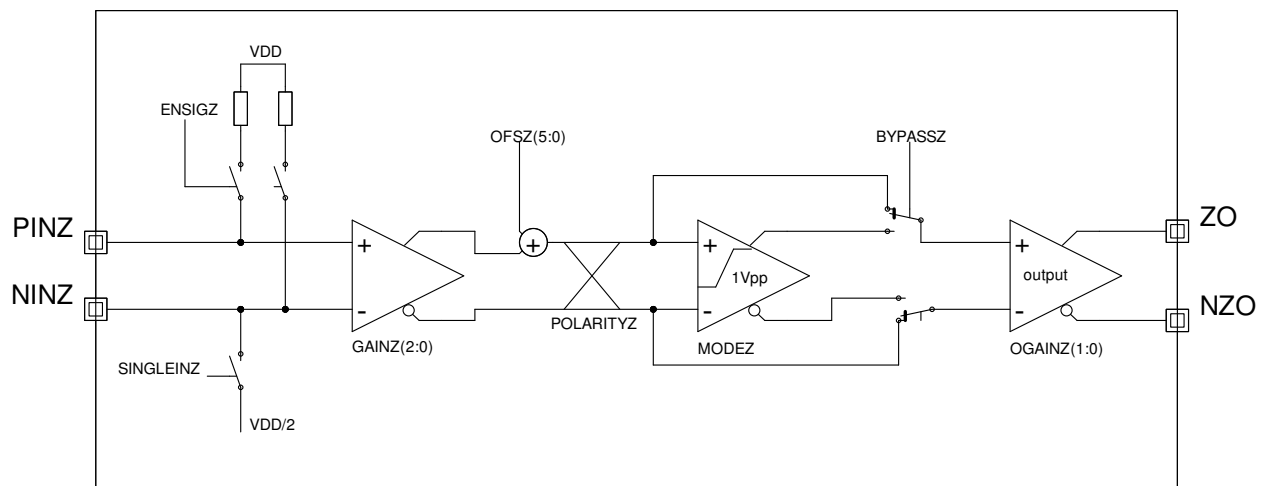


Figure 5: The Z signal path

	Input Amplifier	Output Amplifier	Composite
Gain range	0..36 dB	-3 dB, 0 dB, 6 dB	-3..42 dB
Gain step	6 dB		
Offset Range (input referred*)	$\frac{1.86V}{gain_{input}}$	$\frac{1.86V}{gain_{input}}$	
Offset step input referred	$\frac{60mV}{gain_{input}}$		
	*: $gain_{input} = 10^{\frac{gain_of_input_amplifier_in_dB}{20}}$		

Table 18: Gain and offset characteristics for channel Z

A single ended input referenced to $V_{DD}/2$ is provided by setting bit *SINGLEINZ* of register 0x02. Alternatively, pin NINZ can be biased with an external voltage.

SINGLEINZ	Adr 0x02; Bit 1	R/W
Code	Function	
0	channel Z input is differential (default)	
1	channel Z is single ended	

Table 19: Single ended input functionality

A zero-crossing comparator generates a $1.0V_{peak-peak}$ output signal or a rail-to-rail signal depending on control bit *MODEZ*. The comparator can be bypassed which allows using the Z Path as a regular amplifier path. Bypassing can be toggled via bit *BYPASSZ* of register 0x02.

MODEZ	Adr 0x02; Bit 3	R/W
Code	Function	
0	1 Vpp out (default)	
1	Rail-to-rail output (requires OGAINZ(1:0) set to 0x2)	

Table 20: Channel Z output mode select

BYPASSZ	Adr 0x02; Bit 2	R/W
Code	Function	
0	Comparator is enabled (default)	
1	Comparator is bypassed	

Table 21: Channel Z comparator bypass

Gain and offset

Gain and offset selections on channel Z are made available by providing control bits *GAINZ(2:0)* and *OFSZ(5:0)*. Note that the maximum value for gain on channel Z is 6 which corresponds to a total gain of 36 dB.

GAINZ(2:0) is split up amongst register 0x06 which holds the MSB and register 0x07 holding the other two bits. *OFSZ(5:0)* is the correction value to the output of the input amplifier and is interpreted as 2's complement. The input referred offset is therefore gain dependent.

The output gain on channel Z can be set via control bits *OGAINZ(1:0)*. For more details again refer to section "A/B PATH" on page 14.

GAINZ(2:0) Adr 0x06; Bit 7 Adr 0x07; Bit 1:0		R/W
Code	$gain = gainz \times 6 \text{ dB}$	
0x00	0 dB (default)	
0x01	6 dB	
...		
0x06	36 dB	

Table 22: Gain select for channel Z

OFSZ(5:0) Adr 0x06; Bit 5:0			R/W
Code 2^K	Decimal	$offset = cofz \times 60 \text{ mV}$	
0x21	-31	-1860 mV	
...	...		
0x3F	-1	-60 mV	
0x00	0	0 mV (default)	
0x01	+1	60 mV	
...	...		
0x1F	+31	1860 mV	

Table 23: Offset select for channel Z

OGAINZ(1:0) Adr 0x02; Bit 5:4		R/W
Code	Function	
0x00	0 dB (default)	
0x01	reserved	
0x02	+6 dB	
0x03	-3 dB	

Table 24: Output amplifier gain on channel Z

Input error detection

Pull-up resistor and error detection on channel Z can be controlled by bit *ENSIGZ* of register 0x03, disabling of the complete Z path can be achieved by setting bit *PDZ* of register 0x04 to 1. For more detailed information on pull-up and power control refer to section "A/B PATH" on page 14 as the behaviour of index path and signal path equal regarding these matters.

ENSIGZ Adr 0x03; Bit 1		R/W
Code	Function	
0	Pull-up resistors disconnected and error reporting disabled (default)	
1	Pull-up resistors and error reporting active on <i>inZ</i>	

Table 25: Input signal error detection control

PDZ Adr 0x04; Bit 2		R/W
Code	Function	
0	Channel Z is enabled (default)	
1	Channel Z is powered down	

Table 26: Power-down control on channel Z

Polarity of channel Z

Furthermore, the polarity on channel Z can be inverted by setting or not setting bit *POLARITYZ*.

POLARITYZ Adr 0x02; Bit 0		R/W
Code	Function	
0	Channel Z has normal polarity (default)	
1	Channel Z has inverted polarity	

Table 27: Channel Z polarity select

AUTOMATIC COMPENSATION

Automatic gain and offset correction is available for dual sensor bridges that are 90° out of phase. These types of sensors are used for encoder applications.

Automatic compensation removes any sensor offset and sets the gain to achieve a fixed output voltage. The target output voltage depends on the output gain $OGAIN(1:0)$ as well as on the control bit $VEXT$. When using an external reference voltage, the appropriate voltage must be applied to pin VC.

VEXT		Adr 0x02; Bit 7	R/W
Code	Function		
0	Internally generated 1 V or 2 V is used as output target voltage, depending on register $OGAIN(1:0)$.		
1	Voltage applied to pin VC defines target output voltage (see Table 29).		

Table 28: Target voltage selection

$OGAIN(1:0)$	Output Gain	$VEXT$	Target Output Voltage V_{ppdiff}
00	0 dB	0	1 V
01	reserved	0	
10	6 dB	0	2 V
11	-3 dB	0	1 V
00	0 dB	1	$2.21 \text{ V} - V(VC)$
01	reserved	1	
10	6 dB	1	$(2.21 \text{ V} - VC) \times 2$
11	-3 dB	1	$2.21 \text{ V} - VC$

Table 29: Target output voltages

Automatic compensation is enabled by setting control bit $DYNAMIC$ of register 0x01 to 1. If enabled, it will constantly alter register $DOFSA/B$ and $DGAINA/B$ to maintain zero offset and the target output amplitude. Control bits $FREQ(1:0)$ of register 0x01 are used to limit the tracking rate. If the input frequency increases above the limit tracking will stop. Normally, it is not required to limit the tracking frequency although it can be useful for certain bandwidth limited sensors.

DYNAMIC		Adr 0x01; Bit 1	R/W
Code	Function		
0	Automatic function is disabled		
1	Automatic function is enabled		

Table 30: Automatic compensation enable

Note that setting $FREQ(1:0)$ to other values than 0 does not affect the signal bandwidth of the amplifier. It merely limits the rate of automatic adaption.

FREQ(1:0)		Adr 0x01; Bit 4:3	R/W
Code	Function		
00	no tracking limit (default)		
01	200 kHz		
10	20 kHz		
11	2 kHz		

Table 31: Automatic compensation adaption rate

In normal operation the compensation algorithm will adjust both gain and offset simultaneously in order to achieve fast convergence. If control bit $GENTLE$ of register 0x01 is set, gain and offset registers are updated alternately. This reduces output jumpiness at the expense of slower convergence.

GENTLE		Adr 0x01; Bit 2	R/W
Code	Function		
0	Gain and offset are updated simultaneously		
1	Gain and offset are updated alternately		

Table 32: Automatic compensation sequence control

Automatic compensation can be used in conjunction with temperature compensation. Automatic compensation will then remove any residual offset or gain mismatch not corrected by the temperature correction algorithm.

TEMPERATURE SENSING

iC-TW3 contains an on-chip temperature sensor. Optionally, an external sensor can be used by setting bit *XCELSIUS* of register 0x02 to 1. An external temperature sensor is useful for remote temperature sensing or in situations where the internal sensor does not provide adequate accuracy. Also, device self-heating due to heavy output loads can have an impact on the internal sensor readings. Connect the external temperature sensor with its analog output to pin KELVIN.

XCELSIUS ADR 0x02; Bit 6		R/W
Code	Function	
0	Select internal temperature sensor (default)	
1	Select external temperature sensor	

Table 33: Temperature sensor select

An ADC converts the analog temperature signal into an 8-bit digital word. In case the on-chip sensor is used the 8-bit value spans a temperature range of -50 °C to 150 °C. It is recommended to calibrate the ADC using register 0x05 even when using an external temperature sensor.

Calibrating the temperature ADC

The raw ADC value can be accessed through register 0x40. A ± 2 increment hysteresis is applied to the ADC value to remove conversion noise and the offset register 0x05 is added. The final value is stored in register 0x12 and is used for temperature compensation.

To achieve best temperature accuracy it is required to calibrate the ADC by correctly programming register 0x05. At any known ambient temperature the register 0x05 is programmed such to read the expected ADC value. As an example, consider the product assembly floor with an ambient temperature of 20 °C. Due to device variation the ADC value read before calibration can be anything between 0 °C to 40 °C. Register 0x05 is now used to tune the ADC output value to the correct binary representation of 20 °C.

CCELSIUS(3:0) ADR 0x05; Bit 3:0		R/W
Code	Bit 3 is sign, bits 2:0 are magnitude of correction	
1111	most negative correction	
...	...	
1001	least negative correction	
1000	no correction	
0000	no correction (default)	
0001	least positive correction	
...	...	
0111	most positive correction	

Table 34: Coarse offset correction

FCELSIUS(3:0) ADR 0x05; Bit 7:4		R/W
Code	Value added to ADC reading is FCELSIUS(3:0) - 8	
0000	-8 (default)	
0001	-7	
...	...	
1111	7	

Table 35: Fine offset correction

CELSIUS(7:0) ADR 0x12; Bit 7:0		R
Data	Function	
0x00	Current temperature ADC value that is used for compensation calculations. Value of this register is $0x40 + FCELSIUS(3:0) - 8$	
0xFF		

Table 36: Temperature data

Temperature alarm

The iC-TW3 features a built-in temperature alarm system. An alarm threshold can be specified by the user via the *TALARM(2:0)* bits in register 0x03. A temperature alarm is asserted once the temperature value generated by the ADC is above the defined threshold. The alarm is indicated by the *ERR_TEMP* bit set to 1 as well as by pin NERR going low.

TALARM(2:0) ADR 0x03; Bit 4:2		R/W
Code	$temp_{threshold} = (TALARM(2:0) \times 16) + 144$	
000	144 (default)	
001	160	
...	...	
110	240	
111	Alarm disabled	

Table 37: Temperature alarm threshold

ERROR CONDITIONS

iC-TW3 maintains three status bits reporting system error conditions. These bits are *ERR_EE*, *ERR_TEMP* and *ERR_SIG* of register 0x03. If any error condition is triggered, i.e. indicated by any of these bits being set to 1, this will also assert pin NERR pulling it low.

ERR_EE Adr 0x03; Bit 5 R	
Code	Error message
0	No error since the last reset
1	One of the following error conditions has occurred since the last reset: 1. EEPROM checksum error* 2. EEPROM read error 3. EEPROM write error
Notes	This error message can not be disabled and its bit status is maintained until the device is reset. *) A permanent logic zero read at SDA does not lead to a checksum error.

Table 38: EEPROM data error

ERR_TEMP Adr 0x03; Bit 6 R	
Code	Error message
0	ADC reading is below value defined in register <i>TALARM(2:0)</i>
1	ADC reading is above value defined in register <i>TALARM(2:0)</i>
Notes	This error is not latched. Disabling temperature monitoring is possible by setting <i>TALARM(2:0)</i> to '111'.

Table 39: Temperature alarm

ERR_SIG Adr 0x03; Bit 7 R	
Code	Error message
0	All input terminals are connected
1	An input terminal is left unconnected
Notes	This error is not latched. To enable this alarm <i>ENSIGAB</i> or <i>ENSIGZ</i> must be set 1.

Table 40: Signal unconnected alarm

TEMPERATURE COMPENSATION

Temperature compensation is enabled by setting control bit *TEMP* of register 0x01. A piece-wise linear interpolation of values stored in a look-up-table (LUT) is employed to calculate the gain and offset for a given temperature. Figure 6 shows a sample configuration with seven breakpoints.

TEMP		Adr 0x01; Bit 0	R/W
Code	Function		
0	Temperature compensation is disabled (default)		
1	Temperature compensation is enabled		

Table 41: Temperature compensation enable

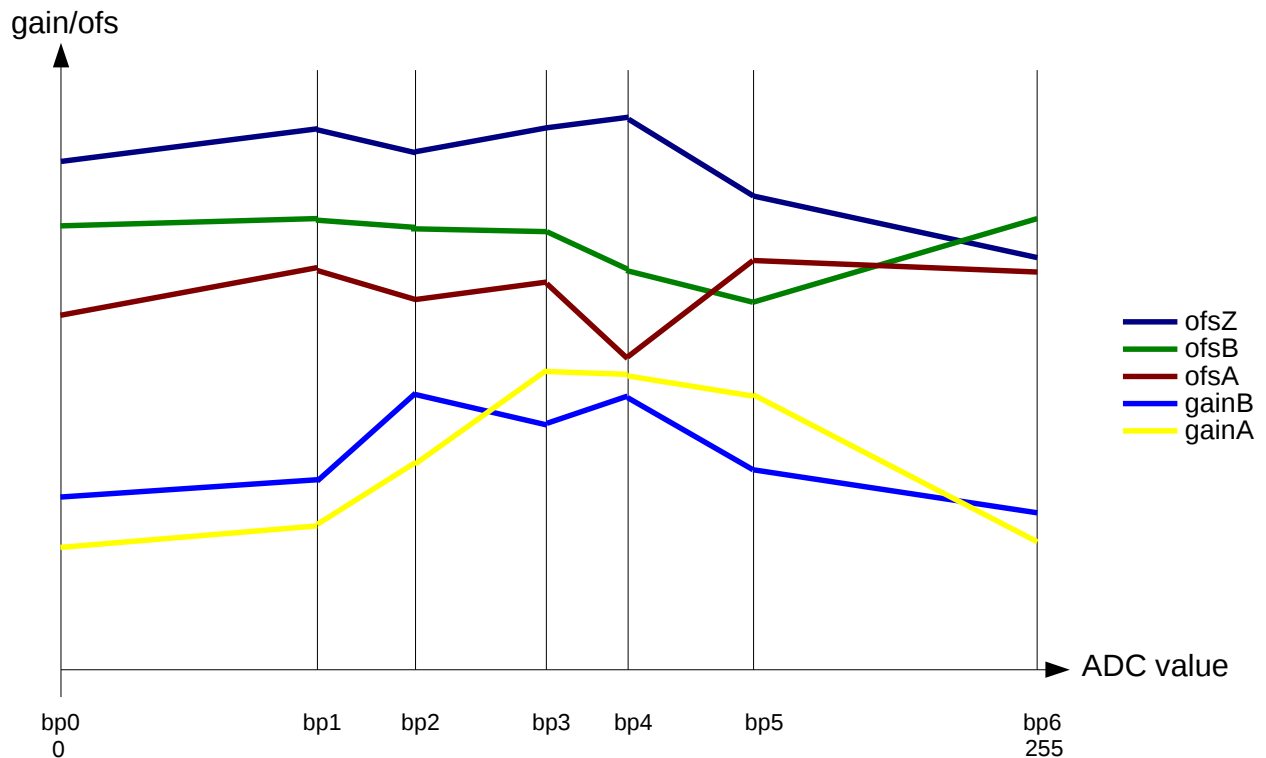


Figure 6: LUT with seven breakpoints

There can be a minimum of two up to a maximum of 16 temperature breakpoints within the LUT. Each breakpoint has five interpolation values associated to it namely *GAINA*, *GAINB*, *OFSA*, *OFSB* and *OFSZ*. For more details on the layout of the LUT refer to section "EEPROM" on page 11.

Breakpoints can be placed freely across the temperature axis except for the first and the last breakpoint. The first breakpoint must be located at ADC value 0 (which roughly corresponds to -50 °C when using the internal sensor), the last breakpoint must be located at ADC value 255 (150 °C with the internal sensor).

The LUT is stored in the off-chip EEPROM from memory location 0x10 onward. Note that the EEPROM address space maps to the 1-wire address 128. Accessing EEPROM address 0 is therefore equivalent to accessing memory location 128 through the 1-wire interface. The breakpoint entry with a value of 255 marks

the last valid LUT entry. All addresses thereafter including their data will be ignored.

Temperature dependent gain and offset is determined by performing linear interpolation between breakpoints. Temperature dependent gain and offset are *TGAINA/B* and *TOFSA/B* respectively.

Fine gain *FGAINA/B* and fine offset *FOFSA/B* (see figure 4 on page 14) are calculated as follows:

$$fgain = tgain + dgain$$

$$fofs = tofs + dofs$$

Whereas *TGAIN* and *TOFS* are the temperature dependent values calculated using the LUT and *DGAIN* and *DOFS* are registers updated either manually or by the automatic compensation function.

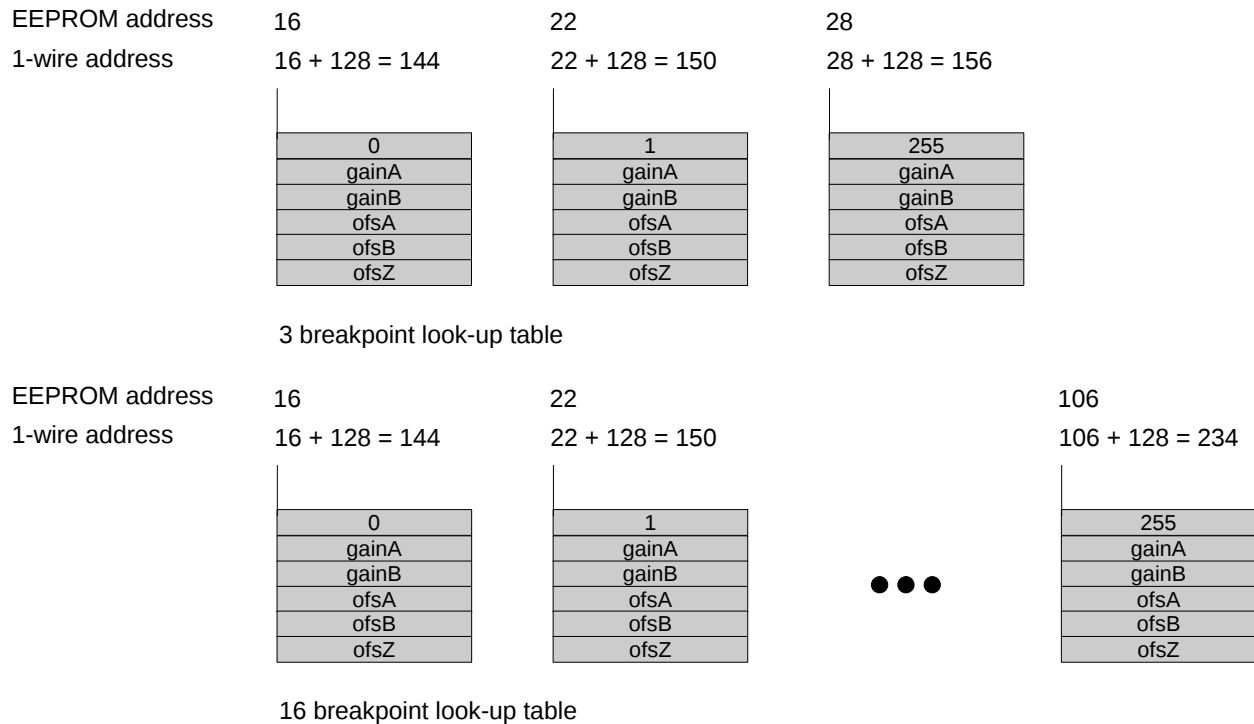


Figure 7: Temperature LUT memory map

TEST MODES

The iC-TW3 possesses two registers 0x0E and 0x10 which provide access to basic testing functionality. The *PD_CELSIUS* bit allows powering off the internal temperature sensor. If powered down, the temperature sensor output value can be forced to a desired value by writing to register 0x40. The user can then test the compensation circuit without cycling the device temperature.

PD_CELSIUS Adr 0x0E; Bit 0 R/W	
Code	Function
0	Temperature sensor enabled (default)
1	Temperature sensor disabled

Table 42: Temperature sensor power control

TEST_CLK Adr 0x0E; Bit 1 R/W	
Code	Function
0	Clock is not driven on any pin (default)
1	Clock is driven on pin NERR

Table 43: Internal clock oscillator

CLKDIV Adr 0x0E; Bit 2 R/W	
Code	Function
1	$f_{\text{system}} = f_{\text{osc}}$ (default)
0	$f_{\text{system}} = f_{\text{osc}} / 2$

Table 44: Internal clock divider selection

TYPICAL APPLICATIONS

A typical application is shown in figure 8. Three differential MR sensor bridges are connected to the iC-TW3. A, B and Z outputs are driving 120Ω terminated transmission lines.

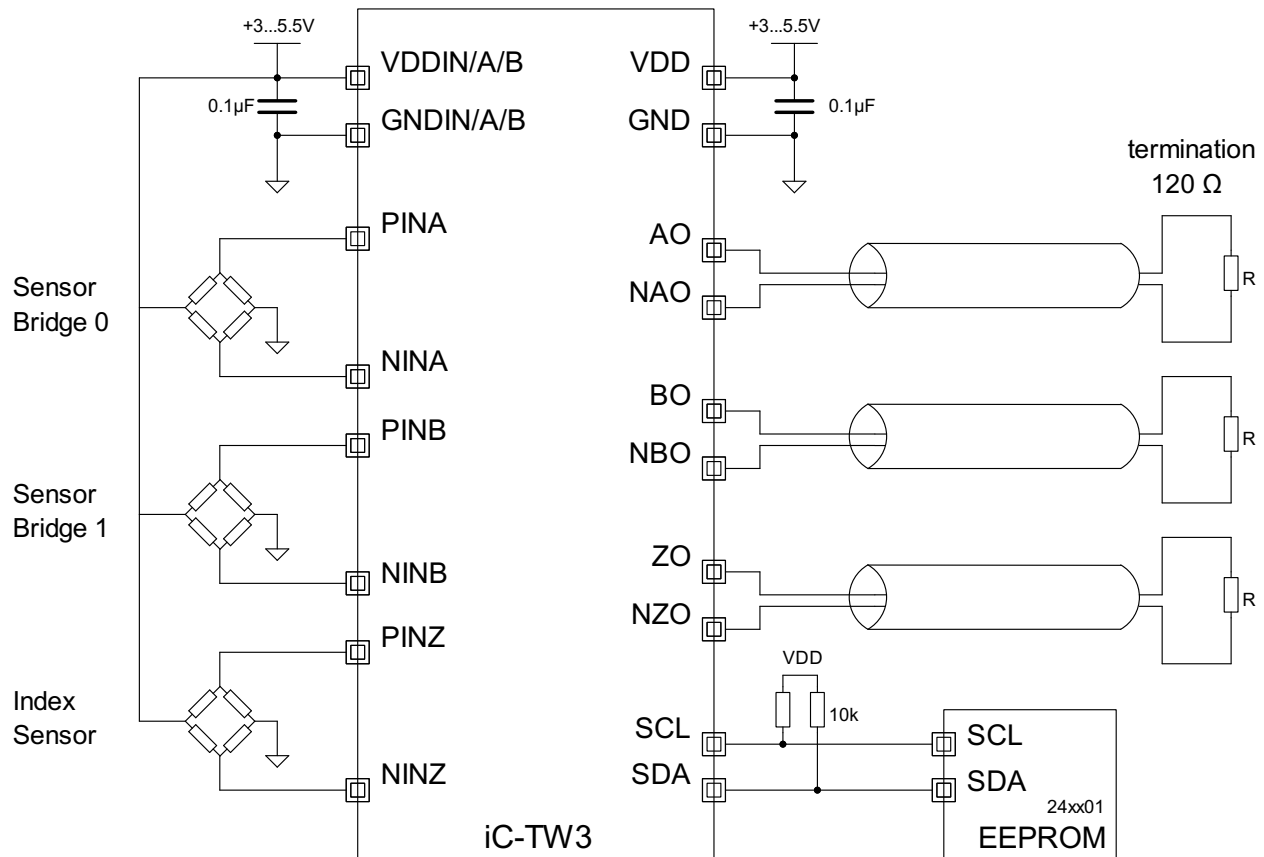


Figure 8: Typical application MR Sensors

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iC-TW3 SENSOR SIGNAL CONDITIONER WITH TEMPERATURE COMPENSATION AND LINE DRIVER



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ORDERING INFORMATION

Type	Package	Order Designation
iC-TW3 Evaluation board	32 pin QFN, 5 mm x 5 mm	iC-TW3 QFN32 TW3D EVAL

For technical support, information about prices and terms of delivery please contact:

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